APPLICABLE STANDARD				
RATING	OPERATING TEMPERATURE RANGE	-30°C TO + 85°C(NOTE 1)	STORAGE TEMPERATURE RANGE	-10°C TO + 60°C(NOTE 2)
	OPERATING HUMIDITY RANGE	40% TO + 80%	STORAGE HUMIDITY RANGE	40% TO + 70%(NOTE 2)
	VOLTAGE	250V AC	VOLTAGE	30V AC
	CURRENT	AWG 22 TO 26 : 2A AWG 28 : 1A AWG 30 : 0.5A	CURRENT	AWG 22 : 2A AWG 24 TO 28 : 1A AWG 30 : 0.5A

SPECIFICATIONS

ITEM	TEST METHOD	REQUIREMENTS	QT	AT
CONSTRUCTION				
GENERAL EXAMINATION	VISUALLY AND BY MEASURING INSTRUMENT.	ACCORDING TO DRAWING.	X	X
MARKING	CONFIRMED VISUALLY.		X	X
ELECTRIC CHARACTERISTICS				
CONTACT RESISTANCE	100 mA (DC OR 1000 Hz).	30 mΩ MAX.	X	—
INSULATION RESISTANCE	500 V DC.	1000 MΩ MIN.	X	—
VOLTAGE PROOF	650 V AC FOR 1 min.	NO FLASHOVER OR BREAKDOWN.	X	—
MECHANICAL CHARACTERISTICS				
MECHANICAL OPERATION	50 TIMES INSERTIONS AND EXTRACTIONS.	① CONTACT RESISTANCE: 30mΩ MAX. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	–
VIBRATION	FREQUENCY 10 TO 55 Hz, SINGLE AMPLITUDE 0.75 mm, AT 2 h, FOR 3 DIRECTIONS.	① NO ELECTRICAL DISCONTINUITY OF 1μs. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	–
SHOCK	490 m/s^2 DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.		X	–
ENVIRONMENTAL CHARACTERISTICS				
RAPID CHANGE OF TEMPERATURE	TEMPERATURE -55→ 5 TO 35→+85→ 5 TO 35 °C TIME 30→ 5 TO 15→ 30→ 5 TO15min UNDER 5 CYCLES.	① CONTACT RESISTANCE: 30mΩ MAX. ② INSULATION RESISTANCE: 1000MΩ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	–
DAMP HEAT (STEADY STATE)	EXPOSED AT 40 ± 2 °C, 90 TO 95 %, 96 h.	① CONTACT RESISTANCE: 30mΩ MAX. ② INSULATION RESISTANCE: 500MΩ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	–

	COUNT	DESCRIPTION OF REVISIONS	DESIGNED	CHECKED	DATE
⓪					

APPROVED	TY.OMA	07.08.02
CHECKED	HK.UMEHARA	07.06.08
DESIGNED	TT.OHSAKO	07.06.08
DRAWN	AK.MIURA	07.06.07

Note QT:Qualification Test AT:Assurance Test X:Applicable Test

DRAWING NO. ELC4-081533-01

HRS	SPECIFICATION SHEET	PART NO.	DF11-14DP-2V(54)	
	HIROSE ELECTRIC CO., LTD.	CODE NO.	CL543-0590-5-54 ⓪	1/2

FORM HD0011-2-1

SPECIFICATIONS

ITEM	TEST METHOD	REQUIREMENTS	QT	AT
RESISTANCE TO SOLDERING HEAT	1) AUTOMATIC SOLDERING (REFLOW) 《REFLOW AREA》 MAX 240℃ WITHIN 10 sec. MIN 220℃ WITHIN 60 sec. 《PREHEATING AREA》 150 TO 180℃ 90 TO 120 s. PUT THROUGH IN REFROW FUMACE TWICE. FEAVE IN AMBIENT TEMPERATURE AND HUMIDITY FOR 1 HOUR. CONNEVCTOR TEMPERATURE TO BE AMBIENT FOR SECOND REFLOW. 2) MANUAL SOLDERING SOLDERING IRON TEMPERATURE :290±10℃, SOLDERING TIME :3s. NO STRENGTH ON CONTACT.	NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS.	X	–
SOLDERABILITY	SOLDERED AT SOLDER TEMPERATURE, 230±5℃ FOR IN IMMERSION , DURATION, 3 s.	A NEW UNIFORM COATING OF SOLDER SHALL COVER MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.	X	–

REMARKS
NOTE 1:INCLUDING THE TEMPERATURE RISE BY CURRENT.
NOTE 2:APPLY TO THE CONDITION OF LONG TERM STORAGE FOR UNUSED PRODUCTS BEFORE PCB ON BOARD , AFTER PCB BOARD , OPERATING TEMPERATURE AND HUMIDITY RANGE IS APPLIED FOR INTERM STORAGE DURING TRANSPORTATION.

Unless otherwise specifid , refer to JIS C 5402.

Note QT:Qualification Test AT:Assurance Test X:Applicable Test		DRAWING NO.	ELC4-081533-01		
HRS	SPECIFICATION SHEET	PART NO.	DF11-14DP-2V(54)		
	HIROSE ELECTRIC CO., LTD.	CODE NO	CL543-0590-5-54	⚠0	2/2

FORM HD0011-2-2